PCN Number:		2020	02100	02		PCN Date:	April 7, 2020					
Title: Datasheet for TR			TPS737-Q1									
Cu	stomer Contact:	PCN I	Manag	er			D	ept	:	Quality Services		
Ch	ange Type:											
	Assembly Site				Design				Nafer	Bump Site		
	Assembly Process			\boxtimes	Data Sheet			<u>ا</u>	Nafer	Bump Material		
Assembly Materials				Part number change				_		Bump Process		
Mechanical Specification					Test Site			-		Fab Site		
Packing/Shipping/Labe		'Labelir	ng		Test Proce	SS				Fab Materials		
									Nafer	Fab Process		
Notification Details												
Description of Change:												
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.												
TEXAS INSTRUMENTS SEVERATED 2009 DEVISED SEDTEMPED 2010												
SBVS123B – DECEMBER 2008–REVISED SEPTEMBER 2019												
Changes from Revision A (July 2016) to Revision B Page												
Changed device temperature grade AEC-Q100 Features bullet												
Deleted sub-bullets from Features output voltage version bullet												
The datasheet number will be changing.												
Device Family				<u>.</u>		Change From:			hange	e To:		
TPS737-Q1					SBVS123A			SBVS123B				
These changes may be reviewed at the datasheet links provided.												
http://www.ti.com/product/TPS737-Q1												
Reason for Change:												
To accurately reflect device characteristics.												
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):												
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.												
Changes to product identification resulting from this PCN:												
None.												
Product Affected:												
	2S73719QDRBRQ1	Т	097373	330								
For questions regarding this notice, e-mails can be sent to the regional contacts shown below or												

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
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Asia Pacific	PCNAsiaContact@list.ti.com
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